



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Koji NOZAKI et al.

Group Art Unit: 1752

Application Number: 10/623,679

Examiner: Amanda C. Walke

Filed: July 22, 2003

Confirmation Number: 5083

For:

RESIST PATTERN THICKENING MATERIAL, RESIST PATTERN

AND PROCESS FOR FORMING THE SAME, AND SEMICONDUCTOR DEVICE AND PROCESS FOR

MANUFACTURING THE SAME

Attorney Docket Number:

030891

Customer Number:

38834

## **AMENDMENT AFTER FINAL**

MAILSTOP: AF

Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450 October 10, 2006

Sir:

This paper is filed in response to the Office Action dated July 10, 2006.

Amendments to the Claims are reflected in the listing of claims that begins on page 2 of this paper.

Remarks begin on page 11 of this paper.

Do Not Enter

PRIMARY EXAMINER